

## FEATURES:

- Typical  $t_{sk(o)}$  (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- $V_{CC} = 3.3V \pm 0.3V$ , Normal Range
- $V_{CC} = 2.7V$  to  $3.6V$ , Extended Range
- CMOS power levels ( $0.4\mu W$  typ. static)
- All inputs, outputs, and I/O are 5V tolerant
- Supports hot insertion
- Available in SSOP and TSSOP packages

## DRIVE FEATURES:

- High Output Drivers:  $\pm 24mA$
- Reduced system switching noise

## APPLICATIONS:

- 5V and 3.3V mixed voltage systems
- Data communication and telecommunication systems

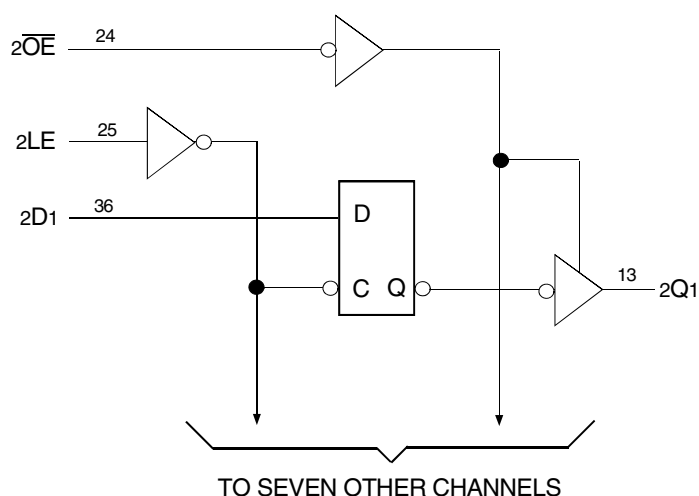
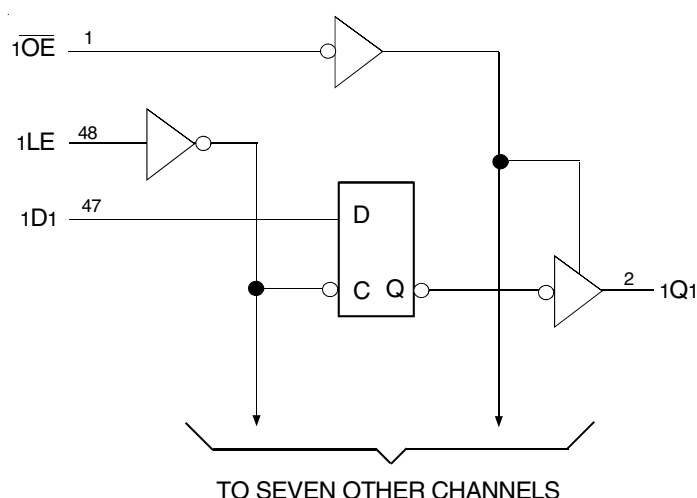
## DESCRIPTION:

The LVC16373A 16-bit transparent D-type latch is built using advanced dual metal CMOS technology. This high-speed, low-power latch is ideal for temporary storage of data. The LVC16373A can be used for implementing memory address latches, I/O ports, and bus drivers. The Output Enable and Latch Enable controls are organized to operate each device as two 8-bit latches or one 16-bit latch. Flow-through organization of signal pins simplifies layout. All inputs are designed with hysteresis for improved noise margin.

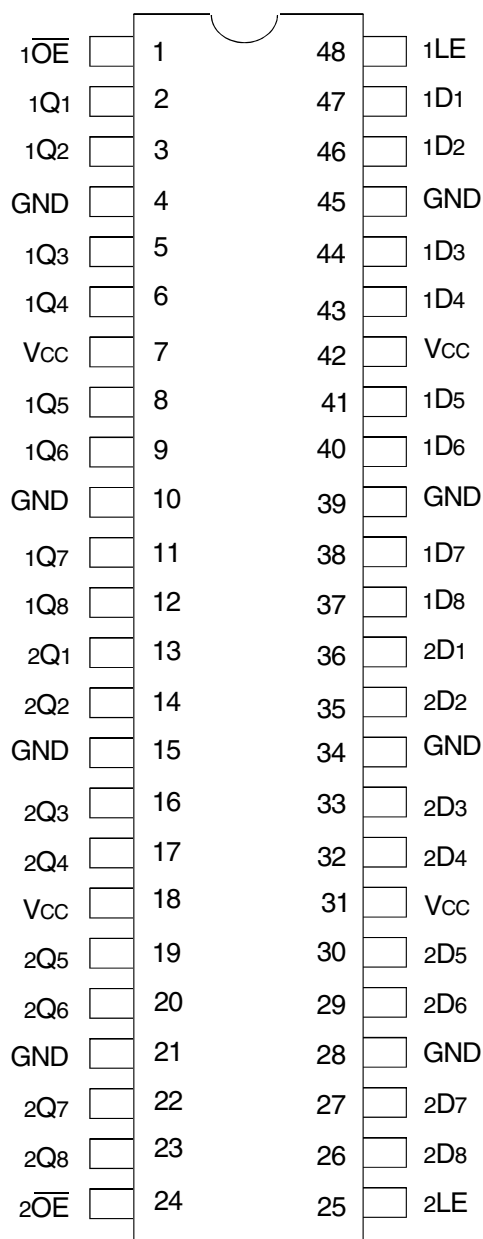
All pins of the LVC16373A can be driven from either 3.3V or 5V devices. This feature allows the use of this device as a translator in a mixed 3.3V/5V supply system.

The LVC16373A has been designed with a  $\pm 24mA$  output driver. This driver is capable of driving a moderate to heavy load while maintaining speed performance.

## FUNCTIONAL BLOCK DIAGRAM



## PIN CONFIGURATION



## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Symbol	Description	Max	Unit
V <sub>TERM</sub>	Terminal Voltage with Respect to GND	−0.5 to +6.5	V
T <sub>STG</sub>	Storage Temperature	−65 to +150	°C
I <sub>OUT</sub>	DC Output Current	−50 to +50	mA
I <sub>IK</sub> I <sub>OK</sub>	Continuous Clamp Current, V <sub>I</sub> < 0 or V <sub>O</sub> < 0	−50	mA
I <sub>CC</sub> I <sub>SS</sub>	Continuous Current through each V <sub>CC</sub> or GND	±100	mA

### NOTE:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## CAPACITANCE (T<sub>A</sub> = +25°C, F = 1.0MHz)

Symbol	Parameter <sup>(1)</sup>	Conditions	Typ.	Max.	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 0V	4.5	6	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V	6.5	8	pF
C <sub>I/O</sub>	I/O Port Capacitance	V <sub>IN</sub> = 0V	6.5	8	pF

### NOTE:

- As applicable to the device type.

## PIN DESCRIPTION

Pin Names	Description
x Dx	Data Inputs
x LE	Latch Enable Input (Active HIGH)
x $\overline{OE}$	Output Enable Inputs (Active LOW)
x Q x	3-State Outputs

## FUNCTION TABLE<sup>(1)</sup>

Inputs			Outputs
x Dx	x LE	x $\overline{OE}$	x Q x
H	H	L	H
L	H	L	L
X	L	L	Q <sup>(2)</sup>
X	X	H	Z

### NOTES:

- H = HIGH Voltage Level  
X = Don't Care  
L = LOW Voltage Level  
Z = High-Impedance
- Output level before the indicated steady-state input conditions were established.

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Condition:  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$

Symbol	Parameter	Test Conditions		Min.	Typ. <sup>(1)</sup>	Max.	Unit
$V_{IH}$	Input HIGH Voltage Level	$V_{CC} = 2.3\text{V}$ to $2.7\text{V}$		1.7	—	—	V
		$V_{CC} = 2.7\text{V}$ to $3.6\text{V}$		2	—	—	
$V_{IL}$	Input LOW Voltage Level	$V_{CC} = 2.3\text{V}$ to $2.7\text{V}$		—	—	0.7	V
		$V_{CC} = 2.7\text{V}$ to $3.6\text{V}$		—	—	0.8	
$I_{IH}$ $I_{IL}$	Input Leakage Current	$V_{CC} = 3.6\text{V}$	$V_I = 0$ to $5.5\text{V}$	—	—	$\pm 5$	$\mu\text{A}$
$I_{OZH}$ $I_{OZL}$	High Impedance Output Current (3-State Output pins)	$V_{CC} = 3.6\text{V}$	$V_O = 0$ to $5.5\text{V}$	—	—	$\pm 10$	$\mu\text{A}$
$I_{OFF}$	Input/Output Power Off Leakage	$V_{CC} = 0\text{V}$ , $V_{IN}$ or $V_O \leq 5.5\text{V}$		—	—	$\pm 50$	$\mu\text{A}$
$V_{IK}$	Clamp Diode Voltage	$V_{CC} = 2.3\text{V}$ , $I_{IN} = -18\text{mA}$		—	-0.7	-1.2	V
$V_H$	Input Hysteresis	$V_{CC} = 3.3\text{V}$		—	100	—	mV
$I_{CCL}$ $I_{CCH}$ $I_{CCZ}$	Quiescent Power Supply Current	$V_{CC} = 3.6\text{V}$	$V_{IN} = \text{GND}$ or $V_{CC}$	—	—	10	$\mu\text{A}$
			$3.6 \leq V_{IN} \leq 5.5\text{V}^{(2)}$	—	—	10	
$\Delta I_{CC}$	Quiescent Power Supply Current Variation	One input at $V_{CC} - 0.6\text{V}$ , other inputs at $V_{CC}$ or GND		—	—	500	$\mu\text{A}$

### NOTES:

- Typical values are at  $V_{CC} = 3.3\text{V}$ ,  $+25^{\circ}\text{C}$  ambient.
- This applies in the disabled state only.

## OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions <sup>(1)</sup>		Min.	Max.	Unit
$V_{OH}$	Output HIGH Voltage	$V_{CC} = 2.3\text{V}$ to $3.6\text{V}$	$I_{OH} = -0.1\text{mA}$	$V_{CC} - 0.2$	—	V
		$V_{CC} = 2.3\text{V}$	$I_{OH} = -6\text{mA}$	2	—	
		$V_{CC} = 2.3\text{V}$	$I_{OH} = -12\text{mA}$	1.7	—	
		$V_{CC} = 2.7\text{V}$		2.2	—	
		$V_{CC} = 3\text{V}$		2.4	—	
		$V_{CC} = 3\text{V}$		2.2	—	
		$V_{CC} = 3\text{V}$	$I_{OH} = -24\text{mA}$	2.2	—	
$V_{OL}$	Output LOW Voltage	$V_{CC} = 2.3\text{V}$ to $3.6\text{V}$	$I_{OL} = 0.1\text{mA}$	—	0.2	V
		$V_{CC} = 2.3\text{V}$	$I_{OL} = 6\text{mA}$	—	0.4	
			$I_{OL} = 12\text{mA}$	—	0.7	
		$V_{CC} = 2.7\text{V}$	$I_{OL} = 12\text{mA}$	—	0.4	
		$V_{CC} = 3\text{V}$	$I_{OL} = 24\text{mA}$	—	0.55	

### NOTE:

- $V_{IH}$  and  $V_{IL}$  must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate  $V_{CC}$  range.  
 $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

OPERATING CHARACTERISTICS,  $V_{CC} = 3.3V \pm 0.3V$ ,  $T_A = 25^\circ C$

Symbol	Parameter	Test Conditions	Typical	Unit
CPD	Power Dissipation Capacitance per Latch Outputs enabled	$C_L = 0pF$ , $f = 10MHz$	39	pF
CPD	Power Dissipation Capacitance per Latch Outputs disabled		6	

SWITCHING CHARACTERISTICS<sup>(1)</sup>

Symbol	Parameter	$V_{CC} = 2.7V$		$V_{CC} = 3.3V \pm 0.3V$		Unit
		Min.	Max.	Min.	Max.	
$t_{PLH}$ $t_{PHL}$	Propagation Delay xDx to xQx	—	4.9	1.6	4.2	ns
$t_{PLH}$ $t_{PHL}$	Propagation Delay xLE to xQx	—	5.3	2.1	4.6	ns
$t_{PZH}$ $t_{PZL}$	Output Enable Time $\overline{xOE}$ to xQx	—	5.7	1.3	4.7	ns
$t_{PHZ}$ $t_{PLZ}$	Output Disable Time $\overline{xOE}$ to xQx	—	6.3	2.5	5.9	ns
$t_{SU}$	Set-up Time, data before LE↓ HIGH or LOW	1.7	—	1.7	—	ns
$t_H$	Hold Time, data after LE↓ HIGH or LOW	1.2	—	1.2	—	ns
$t_W$	Pulse Width LE HIGH	3.3	—	3.3	—	ns
$t_{SK(O)}$	Output Skew <sup>(2)</sup>	—	—	—	500	ps

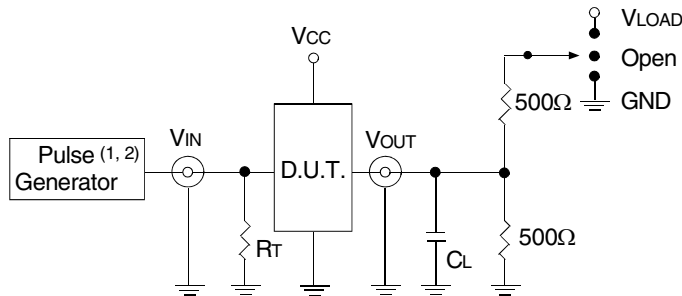
NOTES:

- See TEST CIRCUITS AND WAVEFORMS.  $T_A = -40^\circ C$  to  $+85^\circ C$ .
- Skew between any two outputs of the same package and switching in the same direction.

## TEST CIRCUITS AND WAVEFORMS

### TEST CONDITIONS

Symbol	$V_{CC}^{(1)} = 3.3V \pm 0.3V$	$V_{CC}^{(1)} = 2.7V$	$V_{CC}^{(2)} = 2.5V \pm 0.2V$	Unit
$V_{LOAD}$	6	6	$2 \times V_{CC}$	V
$V_{IH}$	2.7	2.7	$V_{CC}$	V
$V_T$	1.5	1.5	$V_{CC} / 2$	V
$V_{LZ}$	300	300	150	mV
$V_{HZ}$	300	300	150	mV
$C_L$	50	50	30	pF



Test Circuit for All Outputs

#### DEFINITIONS:

$C_L$  = Load capacitance: includes jig and probe capacitance.

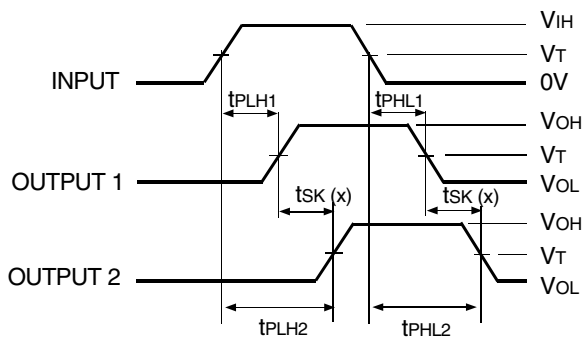
$R_T$  = Termination resistance: should be equal to  $Z_{OUT}$  of the Pulse Generator.

#### NOTES:

1. Pulse Generator for All Pulses: Rate  $\leq 10\text{MHz}$ ;  $t_r \leq 2.5\text{ns}$ ;  $t_f \leq 2.5\text{ns}$ .
2. Pulse Generator for All Pulses: Rate  $\leq 10\text{MHz}$ ;  $t_r \leq 2\text{ns}$ ;  $t_f \leq 2\text{ns}$ .

### SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	$V_{LOAD}$
Disable High Enable High	GND
All Other Tests	Open

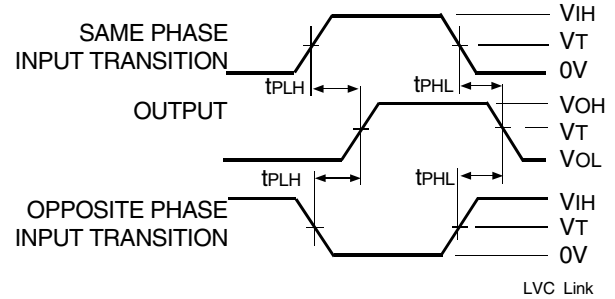


$$t_{SK}(x) = |t_{PLH2} - t_{PLH1}| \text{ or } |t_{PHL2} - t_{PHL1}|$$

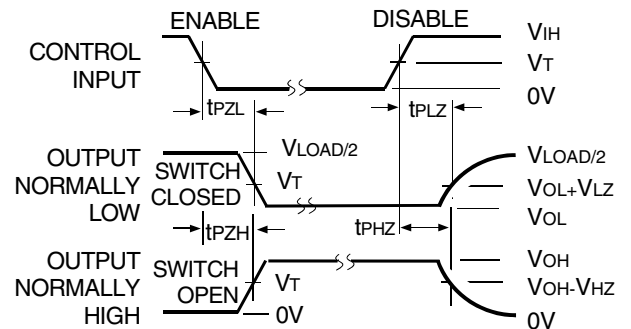
Output Skew -  $t_{SK}(x)$

#### NOTES:

1. For  $t_{SK}(o)$  OUTPUT1 and OUTPUT2 are any two outputs.
2. For  $t_{SK}(b)$  OUTPUT1 and OUTPUT2 are in the same bank.



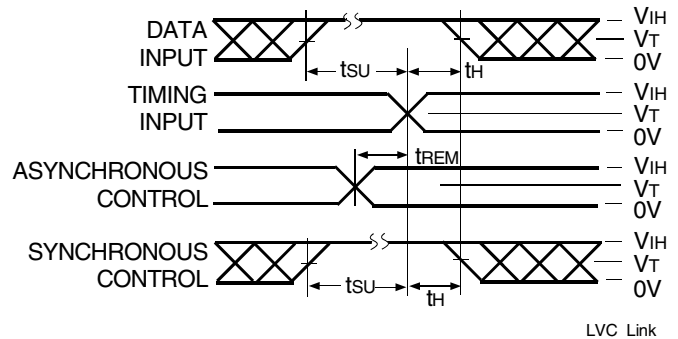
Propagation Delay



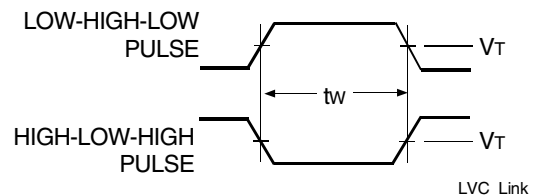
Enable and Disable Times

#### NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.



Set-up, Hold, and Release Times



Pulse Width

XX	LVC	X	XX	XXXX	XX	X		
Temp. Range		Bus-Hold	Family	Device Type	Package			
							Blank 8	Tube or Tray Tape and Reel
							PVG PAG	Shrink Small Outline Package - Green Thin Shrink Small Outline Package - Green
							373A	16-Bit Transparent D-Type Latch with 3-State Outputs
							16	Double-Density, $\pm 24\text{mA}$
							Blank	No Bus-hold
							74	$-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$

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